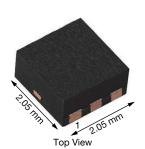
Vishay Siliconix

# P-Channel 20 V (D-S) MOSFET

### PowerPAK® SC-70-6L Single





Marking code: KB

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	-20			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5 \text{ V}$	0.0199			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -2.5 \text{ V}$	0.0285			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -1.8 \text{ V}$	0.0482			
Q <sub>g</sub> typ. (nC)	19.8			
I <sub>D</sub> (A) a, d	-12			
Configuration	Single			

#### **FEATURES**

- TrenchFET® Gen III p-channel power MOSFET
- $R_{DS(on)}$  rating at  $V_{GS} = -1.8 \text{ V}$
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

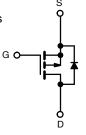


RoHS COMPLIANT

HALOGEN FREE

#### **APPLICATIONS**

- Battery management in mobile devices
- · Battery switch
- · Load switch
- PA switch



P-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SC-70
Lead (Pb)-free and halogen-free	SiA4263DJ-T1-GE3

ABSOLUTE MAXIMUM RATING	<b>iS</b> (Τ <sub>A</sub> = 25 °C, ι	ınless otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-20	V	
Gate-source voltage		V <sub>GS</sub>	± 8	v	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-12 <sup>a</sup>		
	T <sub>C</sub> = 70 °C	1 . 🗀	-12 <sup>a</sup>		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-7.5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		-6 <sup>b, c</sup>		
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	-32	A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		-12 <sup>e</sup>		
	T <sub>A</sub> = 25 °C	l <sub>S</sub>	-2.74 <sup>b, c</sup>		
Single pulse avalanche current	1 0111	I <sub>AS</sub>	-10		
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	5	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		15.6		
	T <sub>C</sub> = 70 °C		10	10/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.29 b, c	W	
	T <sub>A</sub> = 70 °C	1	2.10 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stq</sub>	-55 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient <sup>b</sup>	t ≤ 5 s	R <sub>thJA</sub>	30	38	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	6.5	8	] C/W	

#### Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. Maximum under steady state conditions is 80 °C/W



www.vishay.com Vishay Siliconix

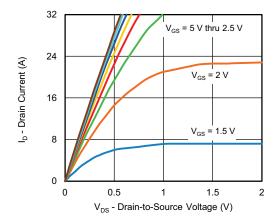
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•			
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-20	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	1 050 A	-	-12	-	\//0/	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	2.5	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-0.4	-	-1	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	-	-	± 100	nA	
Zero gate voltage drain current		V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V	-	-	-1	μА	
	I <sub>DSS</sub>	V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	-10		
Drain-source on-state resistance <sup>a</sup>		$V_{GS} = -4.5 \text{ V}, I_D = -7.5 \text{ A}$	-	0.017	0.022	1	
	R <sub>DS(on)</sub>	$V_{GS} = -2.5 \text{ V}, I_D = -6.4 \text{ A}$	-	0.023	0.030	Ω	
		$V_{GS} = -1.8 \text{ V}, I_D = -2 \text{ A}$	-	0.035	0.0511	1	
Forward transconductance a	9 <sub>fs</sub>	$V_{DS} = -10 \text{ V}, I_D = -7.5 \text{ A}$	-	30	-	S	
Dynamic <sup>b</sup>				1	1		
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	1825	-	pF	
Output capacitance	C <sub>oss</sub>		-	210	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	200	-		
<del>-</del>	0	$Q_g$ $V_{DS} = -10 \text{ V}, V_{GS} = -8 \text{ V}, I_D = -7.5 \text{ A}$	-	34.8	52.2	nC	
Total gate charge	$Q_{g}$		-	19.8	30		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -7.5 \text{ A}$	-	2.6	-		
Gate-drain charge	Q <sub>gd</sub>		-	3	-		
Gate resistance	$R_g$	f = 1 MHz	2.12	10.6	21.2	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	25	38		
Rise time	t <sub>r</sub>	$V_{DD}$ = -10 V, $R_L$ = 1.67 $\Omega$ , $I_D \cong$ -6 A,	-	30	45		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	95	145		
Fall time	t <sub>f</sub>		-	40	60	1	
Turn-on delay time	t <sub>d(on)</sub>		-	8	16	ns	
Rise time	t <sub>r</sub>	$V_{DD}$ = -10 V, $R_L$ = 1.67 $\Omega$ , $I_D \cong$ -6 A,	-	20	30	1	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = -8 \text{ V}, R_g = 1 \Omega$	-	115	173		
Fall time	t <sub>f</sub>		-	40	60		
<b>Drain-Source Body Diode Characteristi</b>	cs						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-8	_	
Pulse diode forward current	I <sub>SM</sub>		-	-	-32	A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -6 A, V <sub>GS</sub> = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	21	32	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = -6 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$	-	9	18	nC	
Reverse recovery fall time	ta	$T_J = 25  ^{\circ}C$	-	9	-		
Reverse recovery rise time	t <sub>b</sub>		-	12	_	ns	

#### Notes

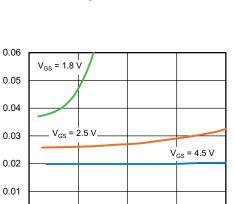
- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





### **Output Characteristics**



R<sub>DS(on)</sub> - On-Resistance (Ω)

0

0

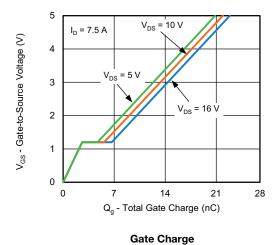
8

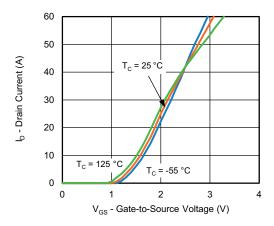
On-Resistance vs. Drain Current and Gate Voltage

16 I<sub>D</sub> - Drain Current (A)

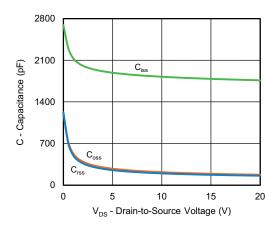
24

32

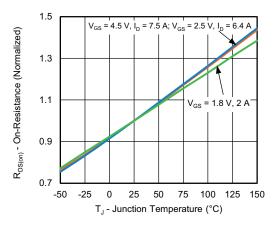




**Transfer Characteristics** 

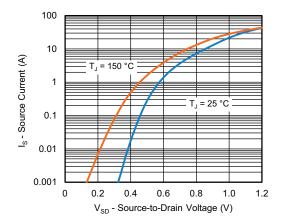


Capacitance

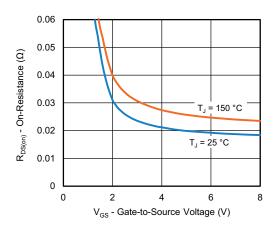


On-Resistance vs. Junction Temperature

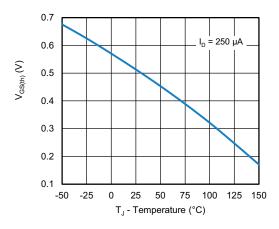




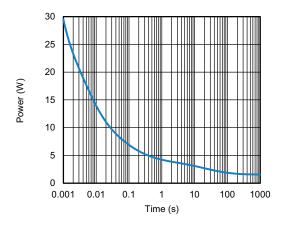
Source-Drain Diode Forward Voltage



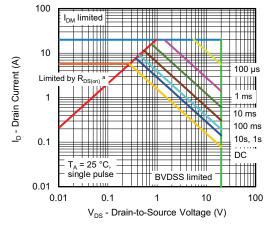
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 

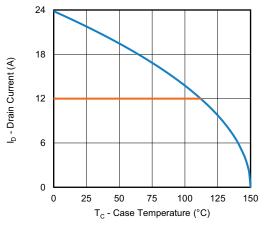


Single Pulse Power, Junction-to-Ambient

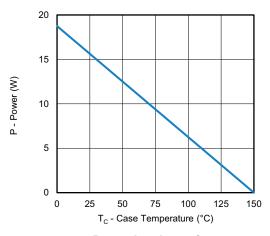


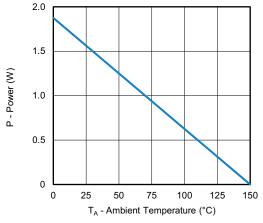
Safe Operating Area, Junction-to-Ambient





Current Derating a





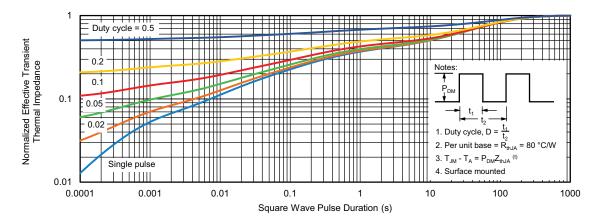
Power, Junction-to-Case

Power, Junction-to-Ambient

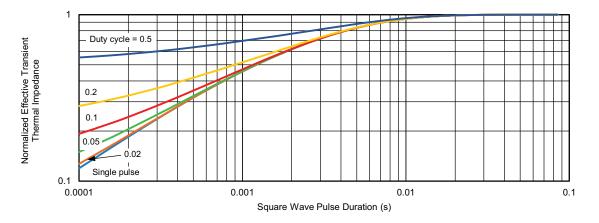
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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